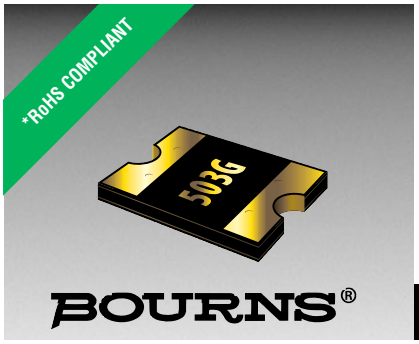


Features

- Very low profile
- Very fast tripping time
- High voltage
- RoHS compliant* and halogen free**
- 2018 footprint
- Agency recognition:

Applications

- Power Over Ethernet (IEEE 802.3 af) port protection
- Automotive electronic control module protection
- Telecom equipment low voltage protection

MF-SMDF Series - PTC Resettable Fuses

Electrical Characteristics

Model	V max. Volts	I max. Amps	I_{hold}	I_{trip}	Resistance		Max. Time To Trip		Tripped Power Dissipation
			Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C
			Hold	Trip	R_{min}	R_{1max}			Typ.
MF-SMDF030 (1)	60	20	0.30	0.80	0.450	2.15	1.2	1.5	0.8
MF-SMDF050	60	10	0.55	1.20	0.200	1.0	2.5	3.0	0.9
MF-SMDF100/33X (1)	33	40	1.10	2.20	0.06	0.40	8.0	0.5	1.4
MF-SMDF150	15	40	1.50	3.00	0.05	0.17	8.0	0.8	1.1
MF-SMDF200 (2)	10	40	2.00	4.00	0.030	0.100	8.0	2.4	1.1
MF-SMDF260/24X (1)	24	20	2.60	5.20	0.015	0.075	8.0	0.8	1.1

(1) TÜV pending. (2) Agency approval pending.

Environmental Characteristics

Operating Temperature ..... -40 °C to +85 °C
Humidity Aging
  MF-SMDF030, 050, 150 & 200 ..... +85 °C, 85 % R.H. 1000 hours ..... ±1.2 % typical resistance change
  MF-SMDF100/33X & 260/24X ..... +85 °C, 85 % R.H. 1000 hours ..... ±5 % typical resistance change
Thermal Shock
  MF-SMDF030, 050, 150 & 200 ..... +85 °C to -40 °C, 20 times ..... ±20 % typical resistance change
  MF-SMDF100/33X & 260/24X ..... +85 °C to -40 °C, 20 times ..... ±10 % typical resistance change
Passive Aging ..... +85 °C, 1000 hours ..... ±5 % typical resistance change
Solvent Resistance ..... MIL-STD-202, Method 215 ..... No change (marking still legible)
Vibration ..... MIL-STD-883C, Method 2007.1, Condition A ..... No change ($R_{min} < R < R_{1max}$)

Test Procedures And Requirements For Model MF-SMDF Series

Test	Test Conditions	Accept/Reject Criteria
Visual/Mech.	Verify dimensions and materials	Per MF physical description
Resistance	In still air @ 23 °C	$R_{min} \le R \le R_{1max}$
Time to Trip	At specified current, Vmax, 23 °C	T ≤ max. time to trip (seconds)
Hold Current	30 min. at Ihold	No trip
Trip Cycle Life	Vmax, Imax, 100 cycles	No arcing or burning
Trip Endurance	Vmax, 48 hours	No arcing or burning
Solderability	ANSI/J-STD-002	95 % min. coverage

UL File Number E174545
http://www.ul.com/ Follow link to Certifications, then UL File No., enter E174545

TÜV Certificate Number ..... R 02057213
http://www.tuvdotcom.com/ Follow link to “other certificates”, enter File No. 2057213

Thermal Derating Chart - I_{hold} (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-SMDF030	0.50	0.43	0.37	0.30	0.25	0.22	0.18	0.15	0.11
MF-SMDF050	0.87	0.77	0.67	0.55	0.46	0.41	0.36	0.31	0.23
MF-SMDF100/33X	1.66	1.47	1.29	1.10	0.91	0.83	0.73	0.64	0.50
MF-SMDF150	2.38	2.10	1.82	1.50	1.27	1.13	0.99	0.85	0.64
MF-SMDF200	2.95	2.65	2.35	2.00	1.74	1.59	1.44	1.29	1.06
MF-SMDF260/24X	3.75	3.35	3.00	2.60	2.35	2.15	2.05	1.80	1.50

*I_{trip} is approximately two times I_{hold}.

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.
**Bourns considers a product to be “halogen free” if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less..

Product Dimensions

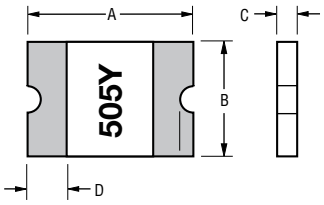
Model	A		B		C		D	E		Style
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.	
MF-SMDF030	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.79 (0.031)	1.09 (0.043)	0.30 (0.012)	N/A	N/A	1
MF-SMDF050	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.79 (0.031)	1.09 (0.043)	0.30 (0.012)	N/A	N/A	1
MF-SMDF100/33X	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.70 (0.028)	1.25 (0.049)	0.30 (0.012)	0.25 (0.010)	0.70 (0.028)	2
MF-SMDF150	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.55 (0.022)	0.85 (0.033)	0.30 (0.012)	N/A	N/A	1
MF-SMDF200	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.55 (0.022)	0.85 (0.033)	0.30 (0.012)	N/A	N/A	1
MF-SMDF260/24X	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.70 (0.028)	2.00 (0.079)	0.30 (0.012)	0.25 (0.010)	0.70 (0.028)	3

Packaging: 6000 pcs. per reel; 4000 pcs. per reel for Model MF-SMDF260/24X.

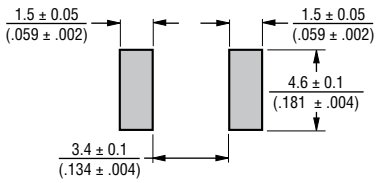
DIMENSIONS: MM (INCHES)

Style 1

Top and Bottom View *Side View*

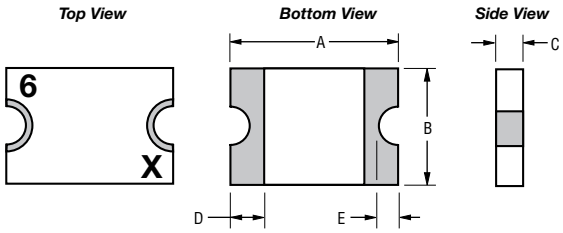


Recommended Pad Layout



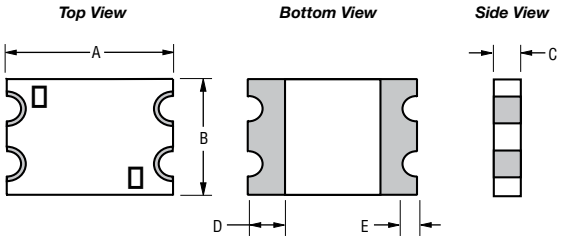
Style 2

Top View *Bottom View* *Side View*



Style 3

Top View *Bottom View* *Side View*



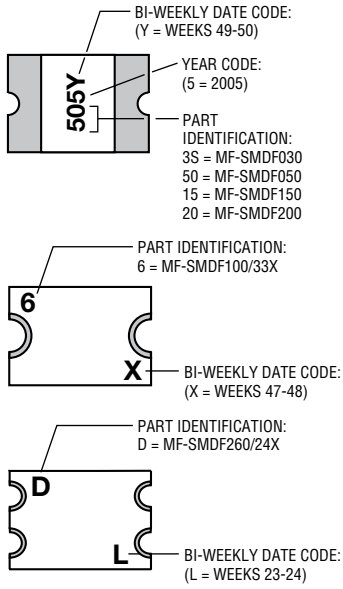
Terminal material:
Electroless Ni under immersion Au

Termination pad solderability:
Standard Au finish:
Meets ANSI/J-STD-002 Category 2.

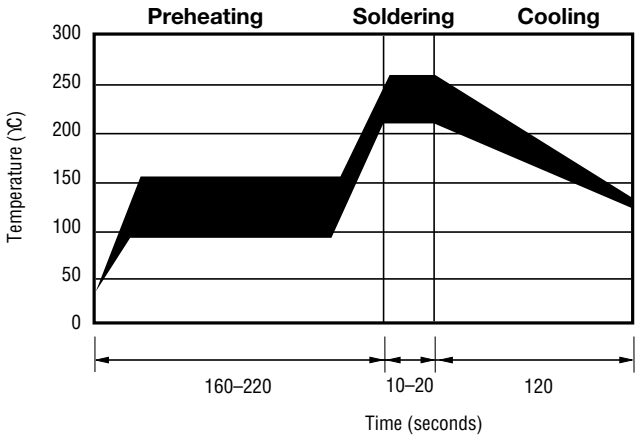
Recommended Storage:
40 °C max./70 % RH max.

Typical Part Marking

Represents total content. Layout may vary.



Solder Reflow Recommendations



Notes:

- MF-SMDF models cannot be wave soldered. Please contact Bourns for hand soldering recommendations.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit, especially during hand soldering. Please refer to the Multifuse® Polymer PTC Soldering Recommendation guidelines.

How to Order

MF - SMDF 100 /33X - 2

Product Designator

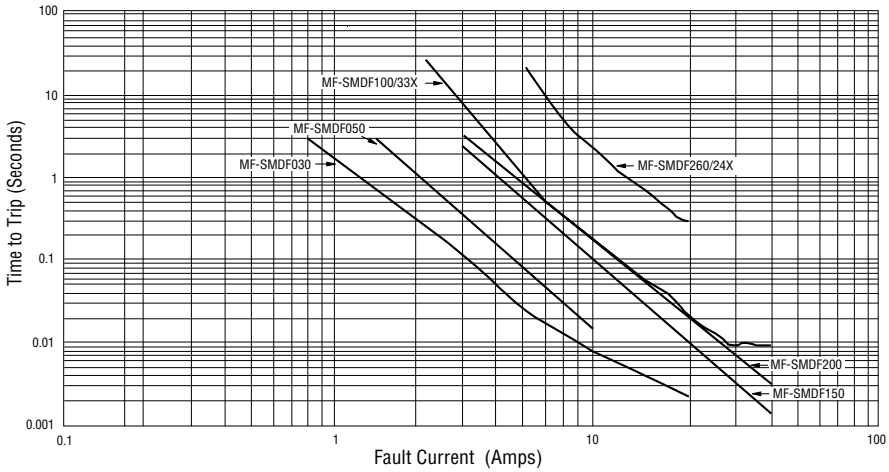
Series
SMDF = 2018 Surface Mount Component

Hold Current, I_{hold}
030 = 0.30 A
050 = 0.50 A
100 = 1.10 A
150 = 1.50 A
200 = 2.00 A
260 = 2.60 A

Higher Voltage Option
__ = Standard Voltage
/24X = 24 V Rated
/33X = 33 V Rated
X = Multifuse® freeXpansion Design™ MF-SMDF Series

Packaging
Packaged per EIA 481-1
-2 = Tape and Reel

Typical Time to Trip at 23 °C



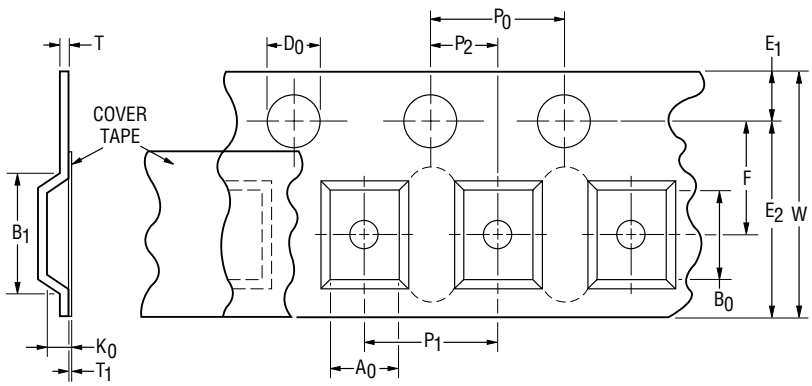
The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

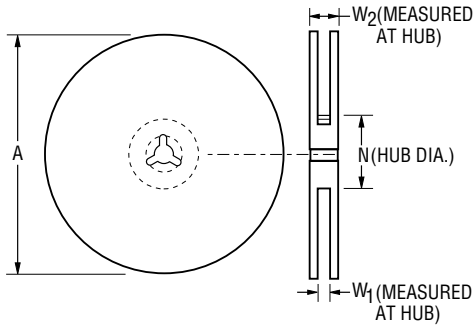
MF-SMDF Series Tape and Reel Specifications

BOURNS®

Tape Dimensions	MF-SMDF030, 050, 150, 200 per EIA 481-2	MF-SMDF100/33X per EIA 481-2	MF-SMDF260/24X per EIA 481-2
W	16.0 ± 0.3 (0.630 ± 0.012)	16.0 ± 0.3 (0.630 ± 0.012)	16.0 ± 0.3 (0.630 ± 0.012)
P_0	4.0 ± 0.1 (0.157 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)
P_1	8.0 ± 0.1 (0.315 ± 0.004)	8.0 ± 0.1 (0.315 ± 0.004)	8.0 ± 0.1 (0.315 ± 0.004)
P_2	2.0 ± 0.1 (0.079 ± 0.004)	2.0 ± 0.1 (0.079 ± 0.004)	2.0 ± 0.1 (0.079 ± 0.004)
A_0	5.1 ± 0.15 (0.201 ± 0.006)	5.1 ± 0.1 (0.201 ± 0.004)	5.4 ± 0.15 (0.213 ± 0.006)
B_0	5.6 ± 0.23 (0.220 ± 0.009)	5.6 ± 0.1 (0.221 ± 0.004)	5.7 ± 0.15 (0.234 ± 0.006)
B_1 max.	12.1 (0.476)	12.1 (0.476)	12.1 (0.476)
D_0	1.5 + 0.1/-0.0 (0.059 + 0.004/-0)	1.5 + 0.1/-0.0 (0.059 + 0.004/-0)	1.5 + 0.1/-0.0 (0.059 + 0.004/-0)
F	7.5 ± 0.10 (0.295 + 0.004)	7.5 ± 0.10 (0.295 + 0.004)	7.5 ± 0.10 (0.295 + 0.004)
E_1	1.75 ± 0.10 (0.069 ± 0.004)	1.75 ± 0.10 (0.069 ± 0.004)	1.75 ± 0.10 (0.069 ± 0.004)
E_2 min.	14.25 (0.561)	14.25 (0.561)	14.25 (0.561)
T max.	0.6 (0.024)	0.6 (0.024)	0.6 (0.024)
T_1 max.	0.1 (0.004)	0.1 (0.004)	0.1 (0.004)
K_0	1.0 ± 0.15 (0.039 ± 0.006)	1.1 ± 0.1 (0.043 ± 0.004)	2.15 ± 0.15 (0.085 ± 0.006)
Leader min.	390 (15.35)	390 (15.35)	390 (15.35)
Trailer min.	160 (6.30)	160 (6.30)	160 (6.30)
Reel Dimensions			
A max.	331 (13.03)	331 (13.03)	331 (13.03)
N min.	50 (1.97)	50 (1.97)	50 (1.97)
W_1	16.4 + 2.0/ -0.0 (0.646 + 0.079/-0)	16.4 + 2.0/ -0.0 (0.646 + 0.079/-0)	16.4 + 2.0/ -0.0 (0.646 + 0.079/-0)
W_2 max.	22.4 (0.882)	22.4 (0.882)	22.4 (0.882)

DIMENSIONS: MM (INCHES)





Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications.